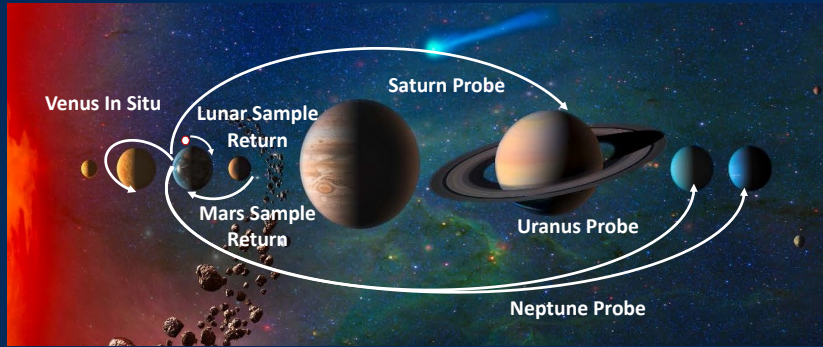
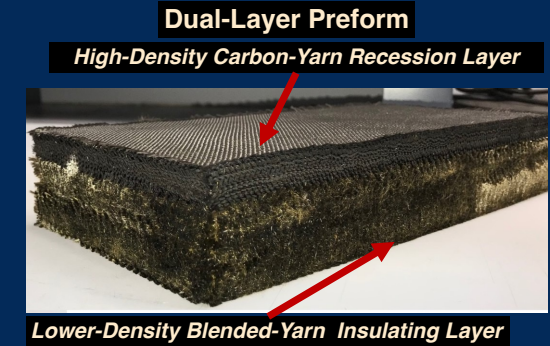
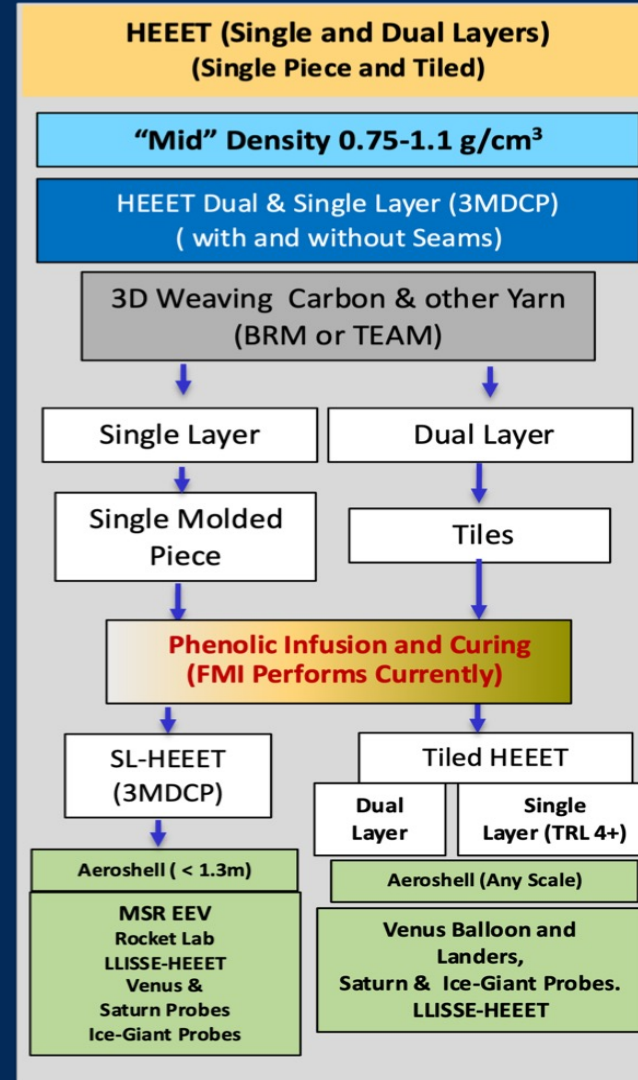
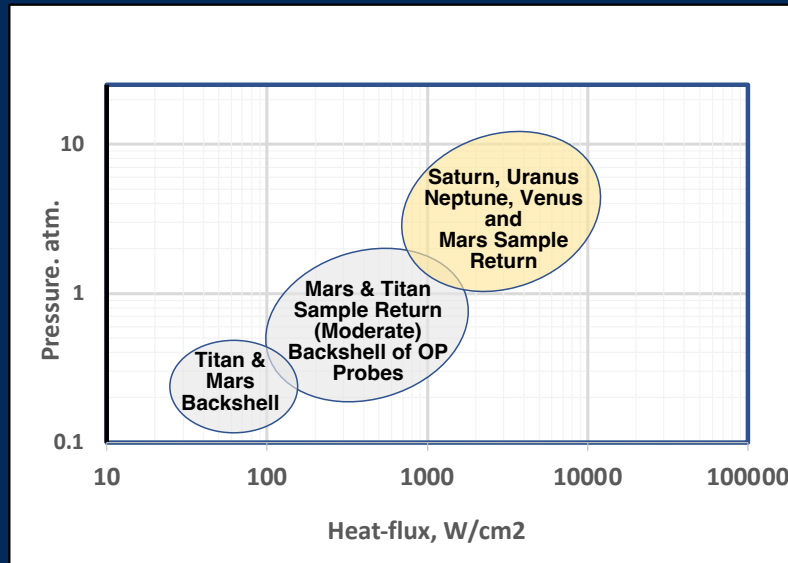


# 3-D Woven TPS Enabling Solar System In-Situ Science Missions



## Destinations and Entry Environment



Dual-Layer HEEET  
 Seamless,  
 Single-Layer  
 3MDCP

Ethiraj Venkatapathy

Representing HEEET and 3MDCP Development Team , NASA Ames Research Center, Moffett Field, CA 94035, USA